

CGB3B3JB1E474K055AB

TDK Item Description : CGB3B3JB1E474KT****



Application & Main Feature

Commercial Grade (Low Profile)

Series

CGB3(1608) [EIA CC0603]



Dimensions

L 1.60mm +/-0.1mm
 W 0.80mm +/-0.1mm
 T 0.55mm Max.
 B 0.20mm Min.
 G 0.30mm Min.

Temperature Characteristic

JB (-25 to 85 degC +/-10%)

Rated Voltage

1E (25Vdc)

Capacitance

470nF

Capacitance Tolerance

K (+/-10%)

Dissipation Factor

7.5% Max.

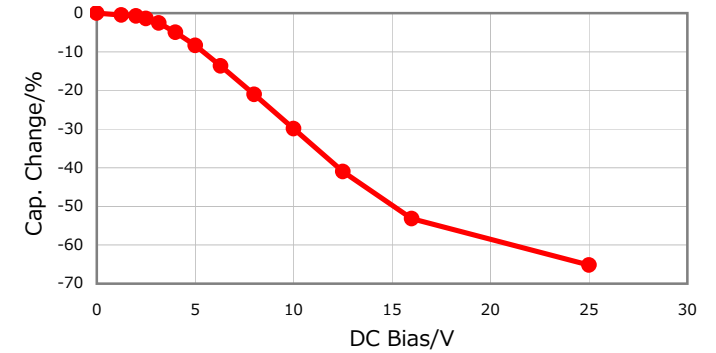
Insulation Resistance

1.06Gohm Min.

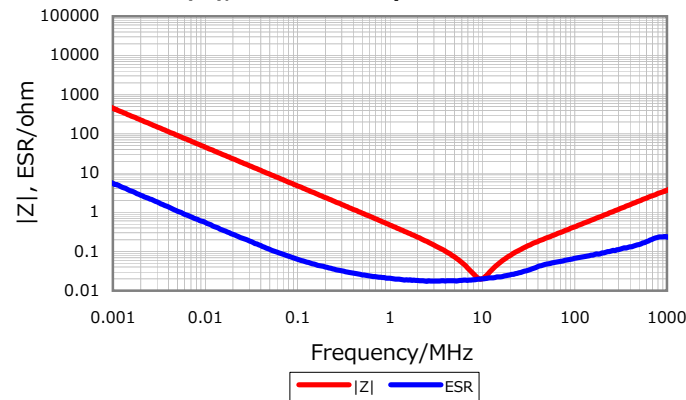
AEC-Q200

Not Applicable

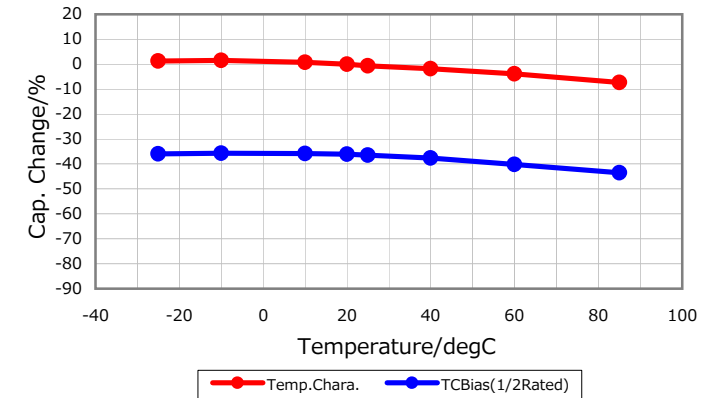
DC Bias Characteristic



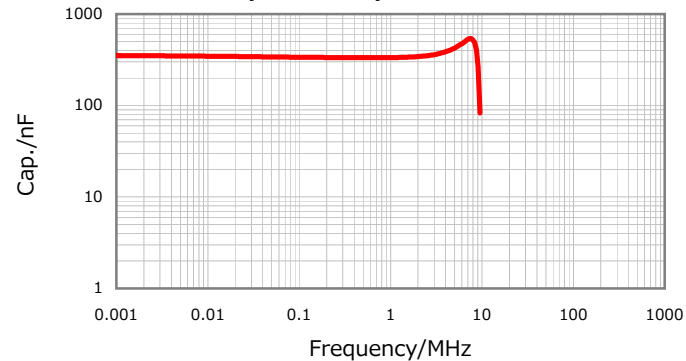
|Z|, ESR vs. Freq. Characteristics



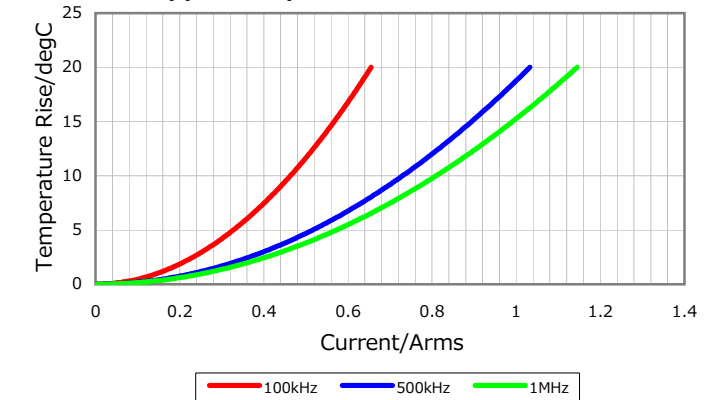
Temperature Characteristics



Cap. vs. Freq. Characteristic



Ripple Temperature Rise Characteristics



Characterization Sheet (Multilayer Ceramic Chip Capacitors)



All specifications are subject to change without notice.

January 4, 2016